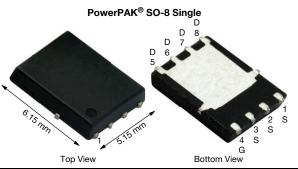
www.vishay.com

Vishay Siliconix



PRODUCT SUMMARY						
V _{DS} (V)	45					
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.00120					
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.00180					
Q _g typ. (nC)	50.5					
I _D (A) ^a	208					
Configuration	Single					

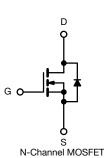
FEATURES

N-Channel 45 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- 45 V Drain-source break-down voltage
- Tuned for low Q_q and Q_{oss}
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- High power density DC/DC
- Motor drive control



ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiR608DP-T1-RE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	45	V	
Gate-source voltage		V _{GS}	+20, -16	v	
	T _C = 25 °C		208		
Continuous drain surrent (T 150 °C)	T _C = 70 °C		166		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	51 ^{b, c}		
	T _A = 70 °C		40.8 ^{b, c}	Τ.	
Pulsed drain current (t = 100 µs)		I _{DM}	400	— A	
Continuous source-drain diode current	T _C = 25 °C		94.5		
	T _A = 25 °C	I _S	5.6 ^{b, c}		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	50		
Single pulse avalanche Energy		E _{AS}	125	mJ	
	T _C = 25 °C		104		
Maximum power dissipation	T _C = 70 °C		66.6		
	T _A = 25 °C	P _D	6.25 ^{b, c}	— W	
	T _A = 70 °C		4 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		
Soldering recommendations (peak temperature) ^{d, e}			260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^{b, f}	t ≤ 10 s	R _{thJA}	15	20	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	0.9	1.2	0/00

Notes

a. Based on T_C = 25 $^\circ C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

Maximum under steady state conditions is 54 °C/W f.

g. Package limited

S18-0952-Rev. A, 17-Sep-2018

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Document Number: 76807

For technical questions, contact: pmostechsupport@vishay.com

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COMPLIANT

HALOGEN

FREE

www.vishay.com

SiR608DP

Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	• •			<u> </u>			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	45	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 10 mA	-	29	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-5.8	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.1	-	2.3	V	
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = +20, -16 V	-	-	± 100	nA	
7		$V_{DS} = 45 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1		
Zero gate voltage drain current	IDSS	$V_{DS} = 45 \text{ V}, V_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	10	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	50	-	-	Α	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-			(
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.00136	0.00180	Ω	
Forward transconductance a	g _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	120	-	S	
Dynamic ^b			•	•			
Input capacitance	C _{iss}		-	8900	-	pF	
Output capacitance	C _{oss}		-	1244	-		
Reverse transfer capacitance	C _{rss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	120	-		
C _{rss} /C _{iss} ratio			-	0.0135	0.0270	-	
		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	111	167		
Total gate charge	Qg		-	50.5	76		
Gate-source charge	Q _{gs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	26	-	nC	
Gate-drain charge	Q _{gd}		-	7.8	-		
Output charge	Q _{oss}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	59	-		
Gate resistance	Rg	f = 1 MHz	0.3	0.88	1.5	Ω	
Turn-on delay time	t _{d(on)}		-	19	38		
Rise time	tr	$V_{DD} = 20 V, R_I = 1 \Omega$	-	10	20		
Turn-off delay time	t _{d(off)}	$I_D \cong 20 \text{ Å}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	50	100		
Fall time	t _f		-	8	16		
Turn-on delay time	t _{d(on)}		-	52	104	ns	
Rise time	t _r	$V_{DD} = 20 V, R_I = 1 \Omega$	-	86	172		
Turn-off delay time	t _{d(off)}	$\text{I}_\text{D}\cong \text{20 A}, \text{V}_\text{GEN}=4.5 \text{ V}, \text{ R}_\text{g}=1 \ \Omega$	-	50	100	1	
Fall time	t _f		-	25	50		
Drain-Source Body Diode Characteristic	s			<u> </u>			
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	94.5		
Pulse diode forward current ($t_p = 100 \ \mu s$)	I _{SM}		-	-	400	A	
Body diode voltage	V _{SD}	I _S = 10 A	-	0.7	1.1	V	
Body diode reverse recovery time	t _{rr}	-	-	52	104	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	71	142	nC	
Reverse recovery fall time	t _a	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	_	32	-		
Reverse recovery rise time	t _b		-	20	-	ns	

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$

b. Guaranteed by design, not subject to production testing

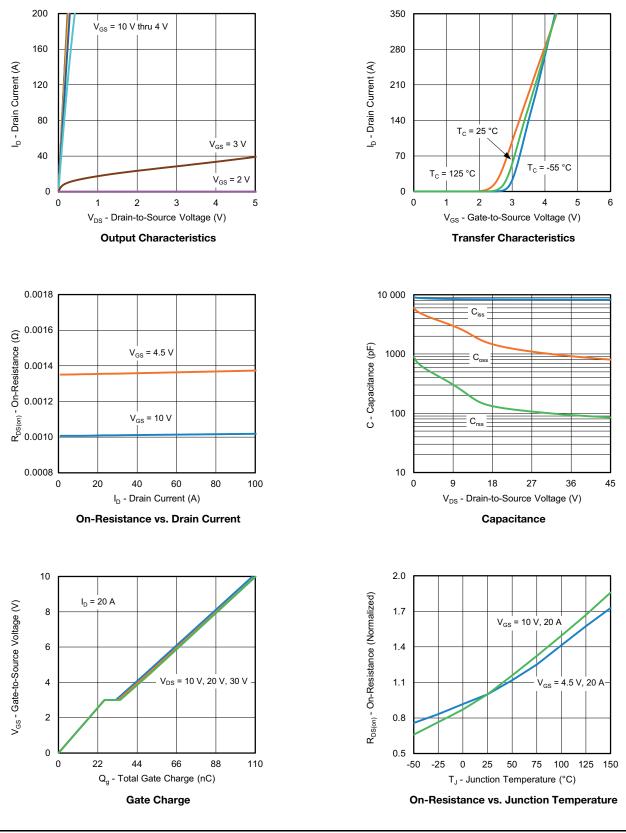
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



S18-0952-Rev. A, 17-Sep-2018

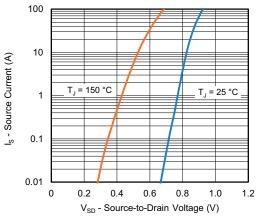
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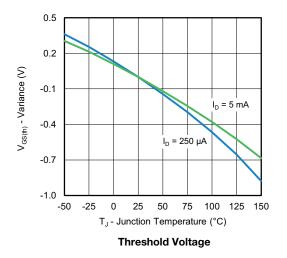


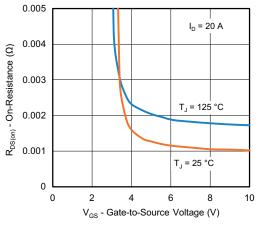
Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

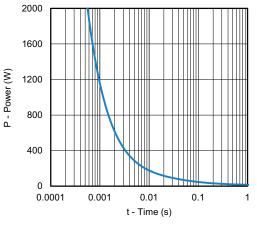


Source-Drain Diode Forward Voltage





On-Resistance vs. Gate-to-Source Voltage

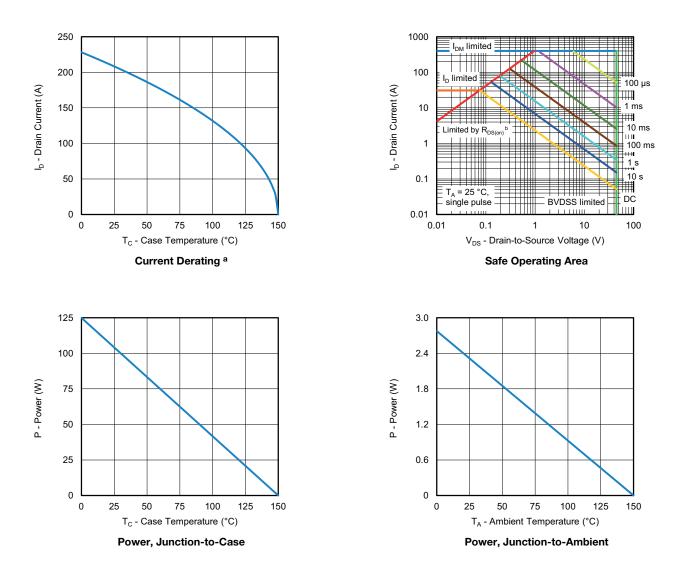


Single Pulse Power, Junction-to-Ambient



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Notes

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

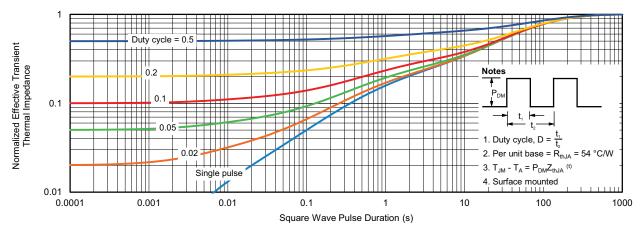
b. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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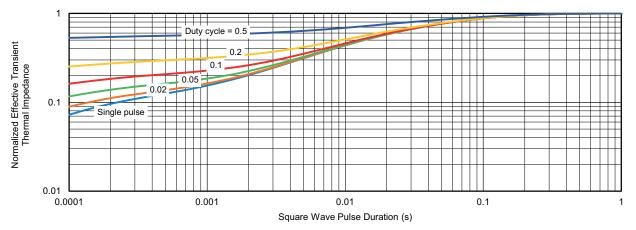


Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?76807.

D2

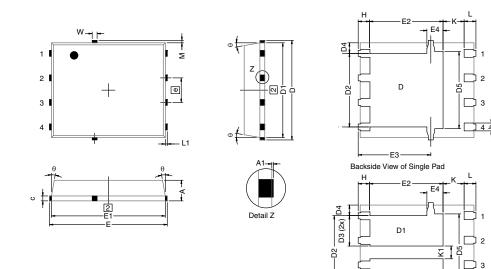
E3

Backside View of Dual Pad



Vishay Siliconix

PowerPAK[®] SO-8, (Single/Dual)



Notes

1. Inch will govern.

2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

514		MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX		
А	0.97	1.04	1.12	0.038	0.041	0.044		
A1		-	0.05	0	-	0.002		
b	0.33	0.41	0.51	0.013	0.016	0.020		
С	0.23	0.28	0.33	0.009	0.011	0.013		
D	5.05	5.15	5.26	0.199	0.203	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.19		
D2	3.56	3.76	3.91	0.140	0.148	0.154		
D3	1.32	1.50	1.68	0.052	0.059	0.066		
D4		0.57 typ.		0.0225 typ.				
D5		3.98 typ.		0.157 typ.				
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	5.79	5.89	5.99	0.228	0.232	0.236		
E2	3.48	3.66	3.84	0.137	0.144	0.15		
E3	3.68	3.78	3.91	0.145	0.149	0.154		
E4		0.75 typ.			0.030 typ.			
е		1.27 BSC			0.050 BSC			
К		1.27 typ.			0.050 typ.			
K1	0.56	-	-	0.022	-	-		
Н	0.51	0.61	0.71	0.020	0.024	0.028		
L	0.51	0.61	0.71	0.020	0.024	0.028		
L1	0.06	0.13	0.20	0.002	0.005	0.008		
θ	0°	-	12°	0°	-	12°		
W	0.15	0.25	0.36	0.006	0.010	0.014		
М		0.125 typ.			0.005 typ.			

1



Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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